

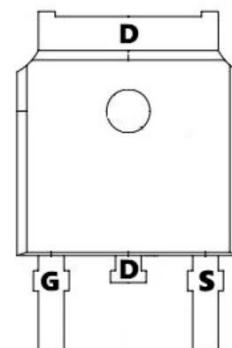
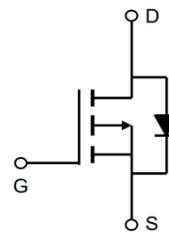


# 70P03

## -30V P-Channel Enhancement Mode MOSFET

### Description

The 70P03 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



### General Features

$V_{DS} = -30V$   $I_D = -70A$

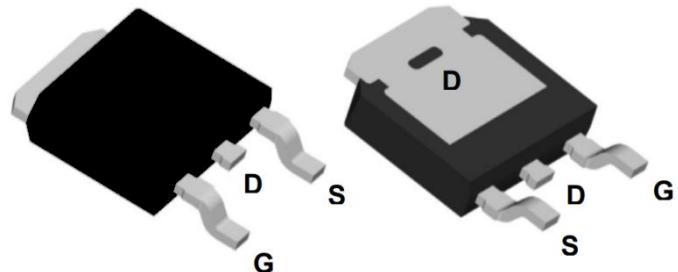
$R_{DS(ON)} < 9.0m\Omega$  @  $V_{GS} = -10V$  (Type: 6.5m $\Omega$ )

### Application

Lithium battery protection

Wireless impact

Mobile phone fast charging



### Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
70P03	TO-252-3L	XX70P03X XXX YYYY	5000

### Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Symbol	Parameter	Max.	Units
VDSS	Drain-Source Voltage	-30	V
VGSS	Gate-Source Voltage	$\pm 20$	V
$I_D$ @ $T_A=25^\circ C$	Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup>	70	A
$I_D$ @ $T_A=70^\circ C$	Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup>	50	A
IDM	Pulsed Drain Current <sup>note1</sup>	-220	A
EAS	Single Pulsed Avalanche Energy <sup>note2</sup>	121	mJ
$P_D$ @ $T_A=25^\circ C$	Power Dissipation	65.2	W
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.9	°C/W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +175	°C



**Electrical Characteristics ( $T_J=25^\circ C$ , unless otherwise noted)**

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D = -250\mu A$	-30	33	-	V
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS}=0V,$	-	-	-1	$\mu A$
IGSS	Gate to Body Leakage Current	$V_{DS}=0V, V_{GS}= \pm 20V$	-	-	$\pm 100$	nA
VGS(th)	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D = -250\mu A$	-1.0	-1.6	-2.5	V
RDS(on)	Static Drain-Source on-Resistance note3	$V_{GS} = -10V, I_D = -30A$	-	6.5	9.0	$m\Omega$
		$V_{GS} = -4.5V, I_D = -20A$	-	11.6	16	
$C_{iss}$	Input Capacitance	$V_{DS} = -15V, V_{GS}=0V,$ $f=1.0MHz$	-	3564	-	pF
$C_{oss}$	Output Capacitance		-	416	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	373	-	pF
$Q_g$	Total Gate Charge	$V_{DS} = -15V, I_D = -20A,$ $V_{GS} = -10V$	-	37	-	nC
$Q_{gs}$	Gate-Source Charge		-	6.5	-	nC
$Q_{gd}$	Gate-Drain("Miller") Charge		-	9.4	-	nC
$t_{d(on)}$	Turn-on Delay Time	$V_{DD} = -15V, I_D = -30A,$ $V_{GS} = -10V, R_{GEN}=2.5\Omega$	-	16	-	ns
$t_r$	Turn-on Rise Time		-	21	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	68	-	ns
$t_f$	Turn-off Fall Time		-	52	-	ns
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	-55	A
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-220	A
VSD	Drain to Source Diode Forward Voltage	$V_{GS}=0V, I_S = -30A$	-	-0.8	-1.2	V

**Note :**

- 1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width .The EAS data shows Max. rating .
- 3、The power dissipation is limited by  $175^\circ C$  junction temperature
- 4、EAS condition:  $T_J=25^\circ C, V_{DD} = -15V, V_G = -10V, R_G=25\Omega, L=0.5mH, I_{AS} = -22A$
- 5、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.



## Typical Characteristics

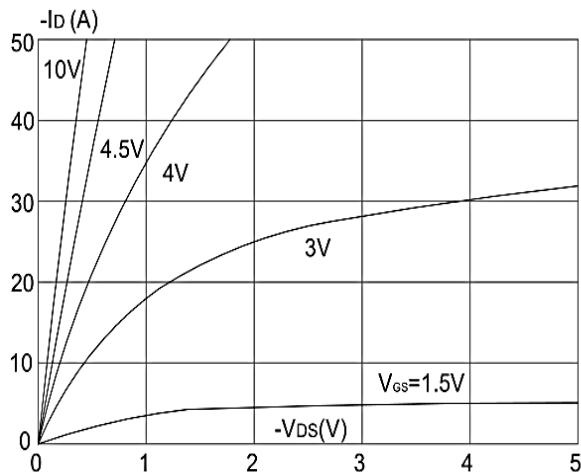


Figure 1: Output Characteristics

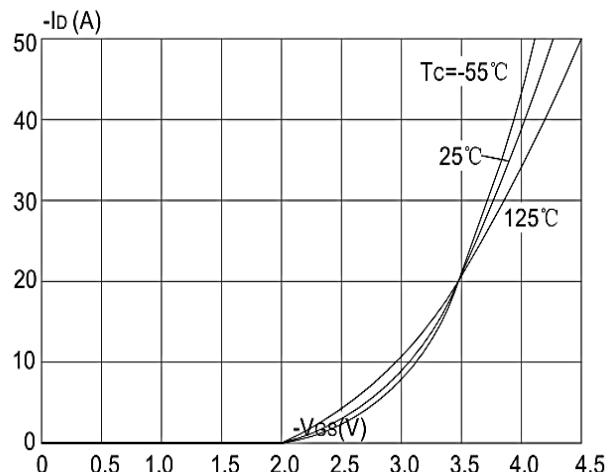


Figure 2: Typical Transfer Characteristics

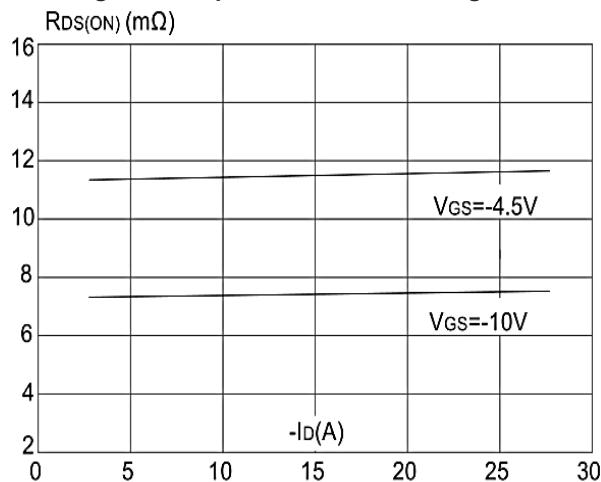


Figure 3: On-resistance vs. Drain Current

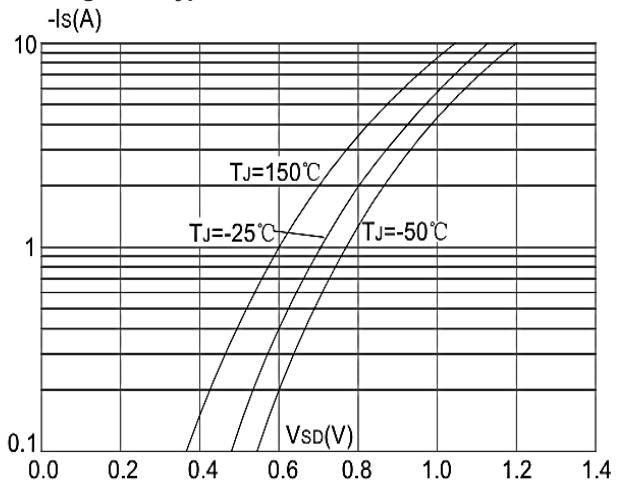


Figure 4: Body Diode Characteristics

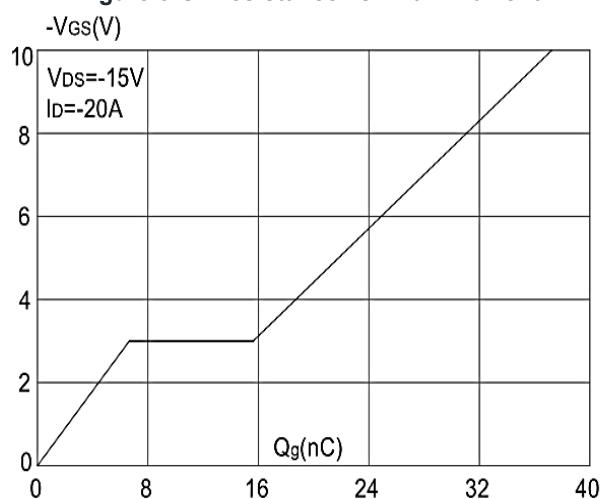


Figure 5: Gate Charge Characteristics

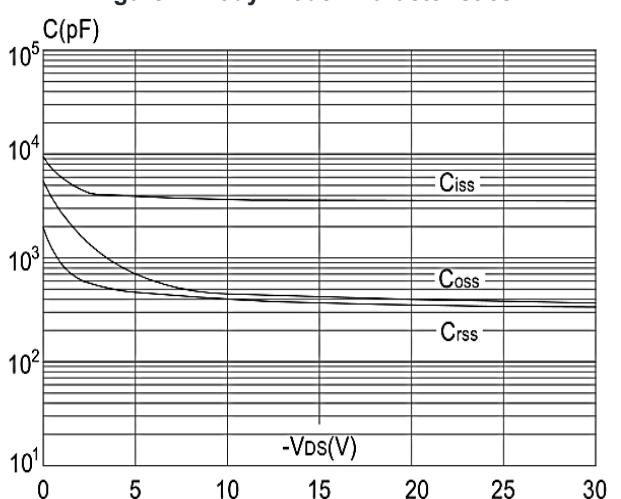
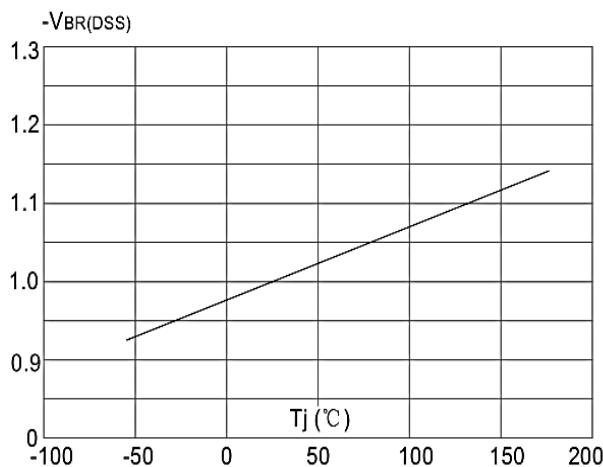
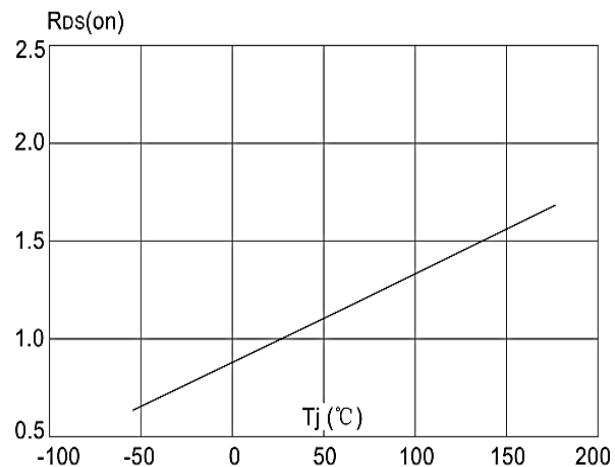


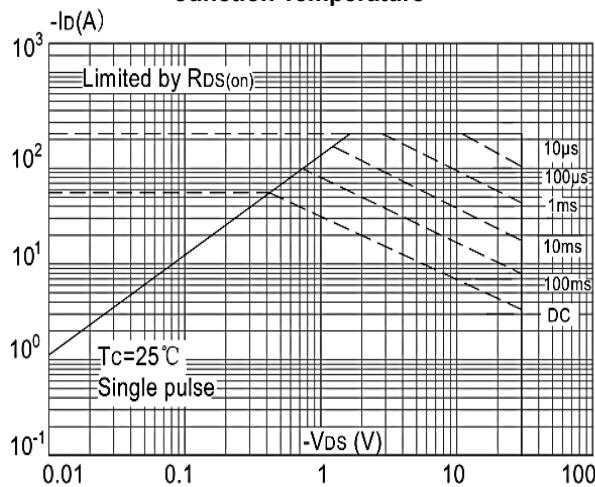
Figure 6: Capacitance Characteristics



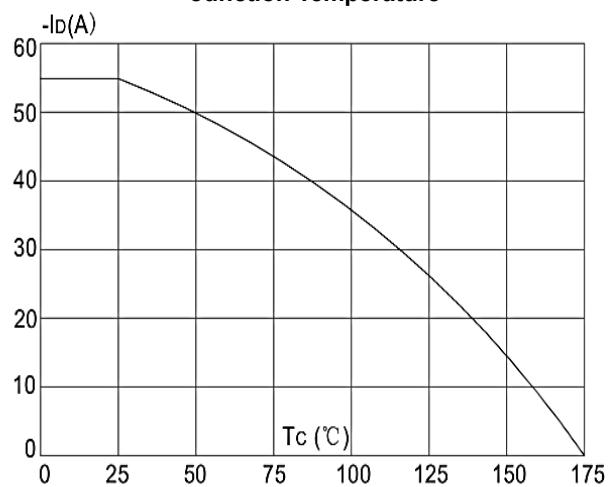
**Figure 7: Normalized Breakdown Voltage vs. Junction Temperature**



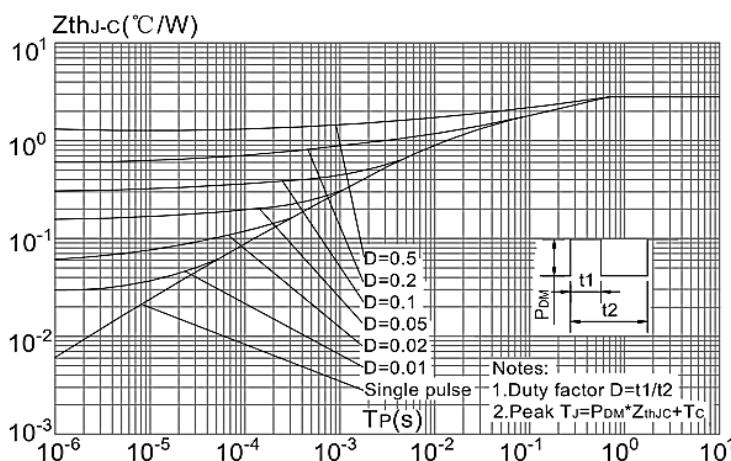
**Figure 8: Normalized on Resistance vs. Junction Temperature**



**Figure 9: Maximum Safe Operating Area**



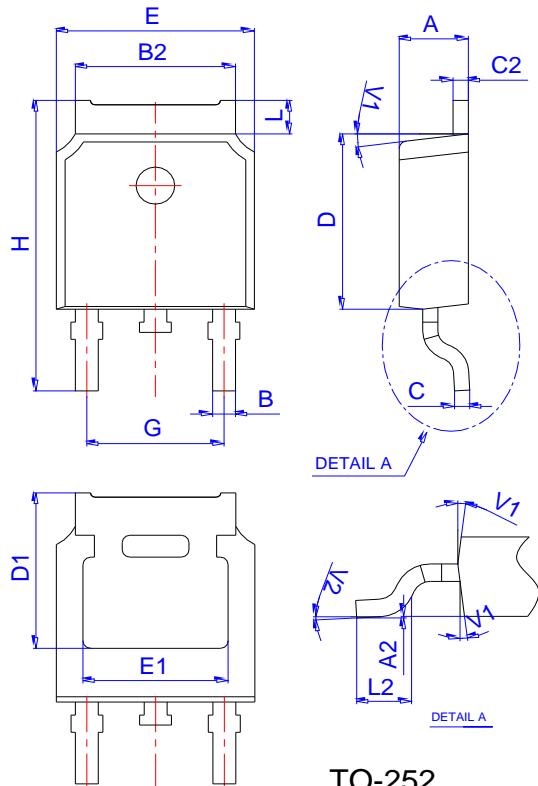
**Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature**



**Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient**



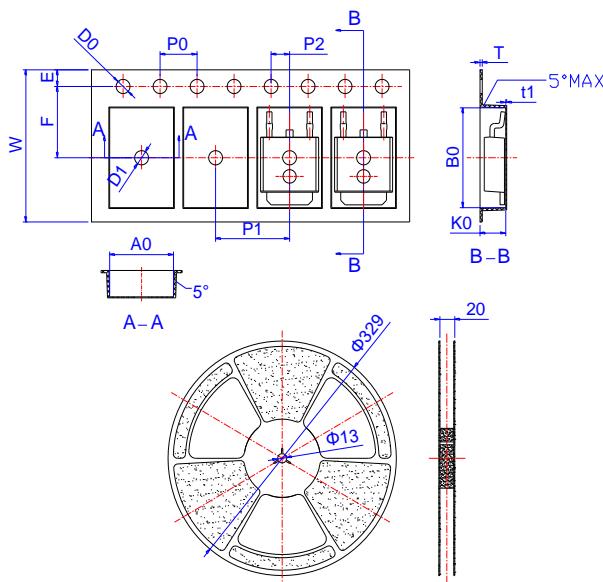
## Package Mechanical Data:TO-252-3L



TO-252

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

## Reel Specification-TO-252



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583